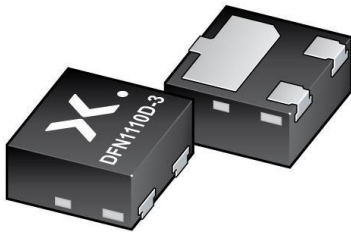


PDTC124XQBZ Datasheet

www.digi-electronics.com



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	PDTC124XQBZ-DG
Manufacturer	Nexperia USA Inc.
Manufacturer Product Number	PDTC124XQBZ
Description	TRANS PREBIAS PNP 50V 0.1A 3DFN
Detailed Description	Pre-Biased Bipolar Transistor (BJT) PNP - Pre-Biased 50 V 100 mA 180 MHz 340 mW Surface Mount, Wettable Flank DFN1110D-3



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.

Purchase and inquiry

Manufacturer Product Number:

PDTC124XQBZ

Series:

-

Transistor Type:

PNP - Pre-Biased

Voltage - Collector Emitter Breakdown (Max):

50 V

Resistor - Emitter Base (R2):

47 kOhms

Vce Saturation (Max) @ Ib, Ic:

100mV @ 250µA, 5mA

Frequency - Transition:

180 MHz

Mounting Type:

Surface Mount, Wettable Flank

Supplier Device Package:

DFN1110D-3

Manufacturer:

Nexperia USA Inc.

Product Status:

Obsolete

Current - Collector (Ic) (Max):

100 mA

Resistor - Base (R1):

22 kOhms

DC Current Gain (hFE) (Min) @ Ic, Vce:

80 @ 5mA, 5V

Current - Collector Cutoff (Max):

100nA

Power - Max:

340 mW

Package / Case:

3-XDFN Exposed Pad

Base Product Number:

PDTC124

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.21.0075

Moisture Sensitivity Level (MSL):

3 (168 Hours)

ECCN:

EAR99



PDTC143X/123J/143Z/114Y/124XQB series

50 V, 100 mA NPN resistor-equipped transistors

Rev. 1 — 1 October 2021

Product data sheet

1. General description

100 mA NPN Resistor-Equipped Transistor (RET) family in an ultra small DFN1110D-3 (SOT8015) leadless Surface-Mounted Device (SMD) plastic package with side-wettable flanks.

Table 1. Product overview

Type number	R1	R2	Package		PNP complement:
	k Ω	k Ω	Nexperia	JEDEC	
PDTC143XQB	4.7	10	SOT8015	MO-340BA	PDTA143XQB
PDTC123JQB	2.2	47			PDTA123JQB
PDTC143ZQB	4.7	47			PDTA143ZQB
PDTC114YQB	10	47			PDTA114YQB
PDTC124XQB	22	47			PDTA124XQB

2. Features and benefits

- 100 mA output current capability
- Built-in resistors
- Simplifies circuit design
- Reduces component count
- Reduces pick and place costs
- Low package height of 0.5 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint

3. Applications

- Digital applications
- Cost saving alternative for BC847 series in digital applications
- Controlling IC inputs
- Switching loads

4. Quick reference data

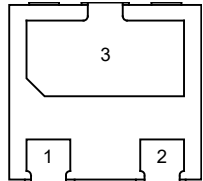
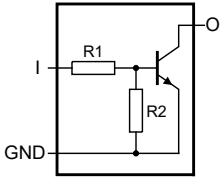
Table 2. Quick reference data

$T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	50	V
I_O	output current		-	-	100	mA

5. Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I	input (base)	 <p>Transparent top view</p>	 <p>aaa-019964</p>
2	GND	GND (emitter)		
3	O	output (collector)		

6. Ordering information

Table 4. Ordering information

Type number	Package		Version
	Name	Description	
PDTC143XQB	DFN1110D-3	plastic leadless extremely thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.65 mm pitch; body: 1.1 x 1.0 x 0.48 mm	SOT8015
PDTC123JQB			
PDTC143ZQB			
PDTC114YQB			
PDTC124XQB			

7. Marking

Table 5. Marking

Type number	Marking code
PDTC143XQB	E7
PDTC123JQB	E3
PDTC143ZQB	E8
PDTC114YQB	E2
PDTC124XQB	E5

8. Limiting values

Table 6. Limiting values

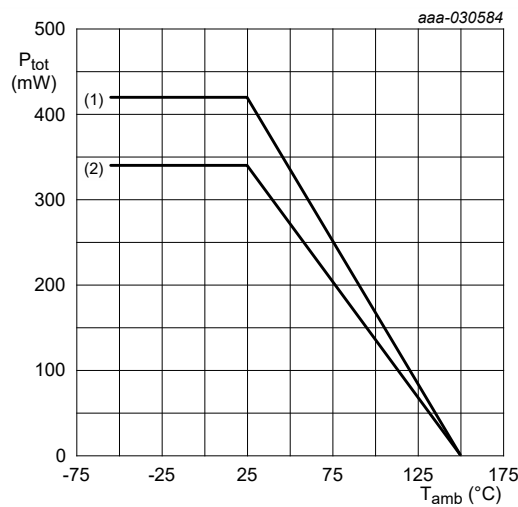
In accordance with the Absolute Maximum Rating System (IEC 60134).

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit	
V_{CBO}	collector-base voltage	open emitter	-	50	V	
V_{CEO}	collector-emitter voltage	open base	-	50	V	
V_{EBO}	emitter-base voltage					
	PDTC143XQB	open collector	-	7	V	
	PDTC123JQB		-	5	V	
	PDTC143ZQB		-	5	V	
	PDTC114YQB		-	6	V	
	PDTC124XQB		-	7	V	
V_i	input voltage					
	PDTC143XQB		-7	+30	V	
	PDTC123JQB		-5	+12	V	
	PDTC143ZQB		-5	+30	V	
	PDTC114YQB		-6	+40	V	
	PDTC124XQB		-7	+40	V	
I_O	output current		-	100	mA	
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	340	mW
			[2]	-	420	mW
T_j	junction temperature		-	150	°C	
T_{amb}	ambient temperature		-55	150	°C	
T_{stg}	storage temperature		-65	150	°C	

[1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided; 35 μm copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB; single-sided; 70 μm copper; tin-plated and standard footprint.



(1) FR4 PCB; single-sided; 70 μm copper; standard footprint

(2) FR4 PCB; single-sided; 35 μm copper; standard footprint

Fig. 1. Power derating curves

9. Thermal characteristics

Table 7. Thermal characteristics

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	368	K/W
			[2]	-	-	298	K/W

- [1] Device mounted on an FR4 PCB; single-sided; 35 μm copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided; 70 μm copper; tin-plated and standard footprint.

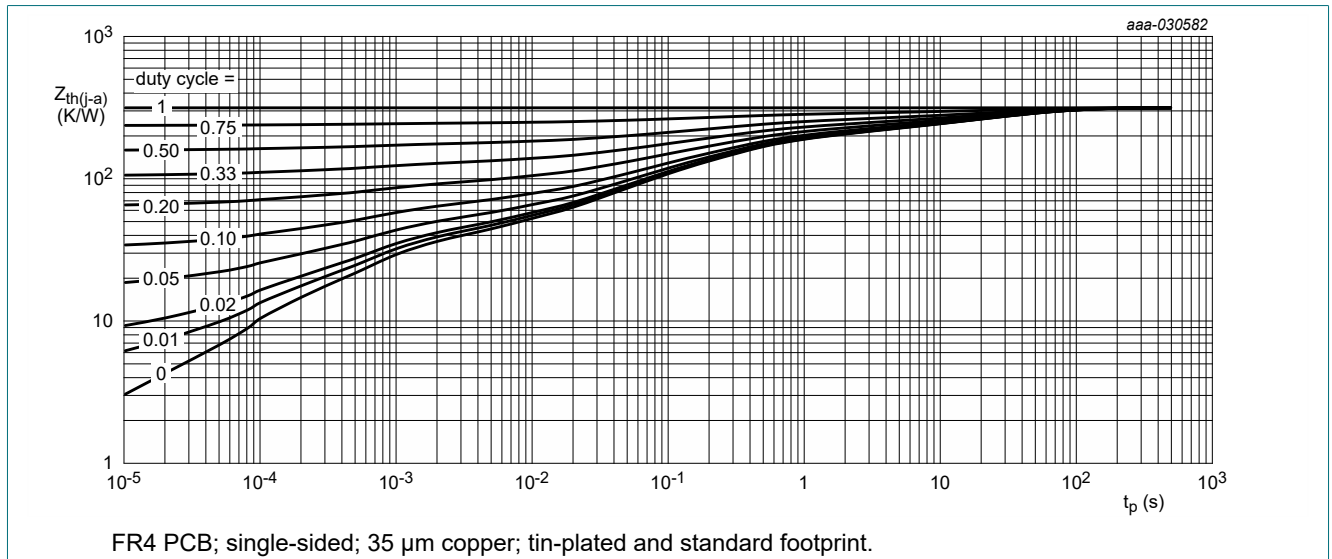


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

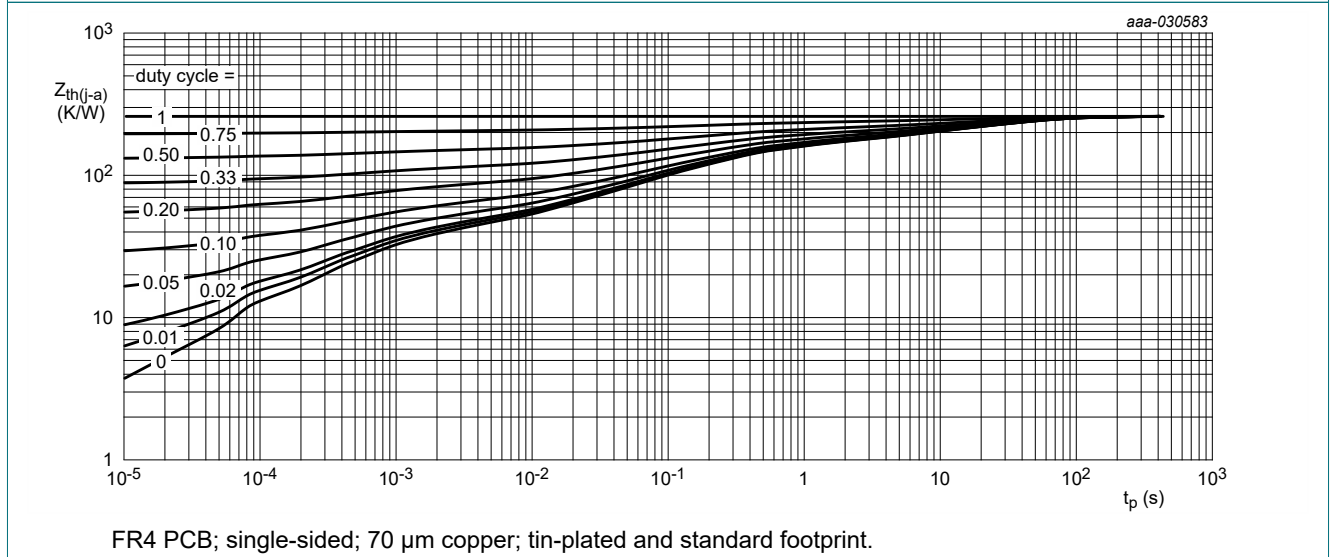


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

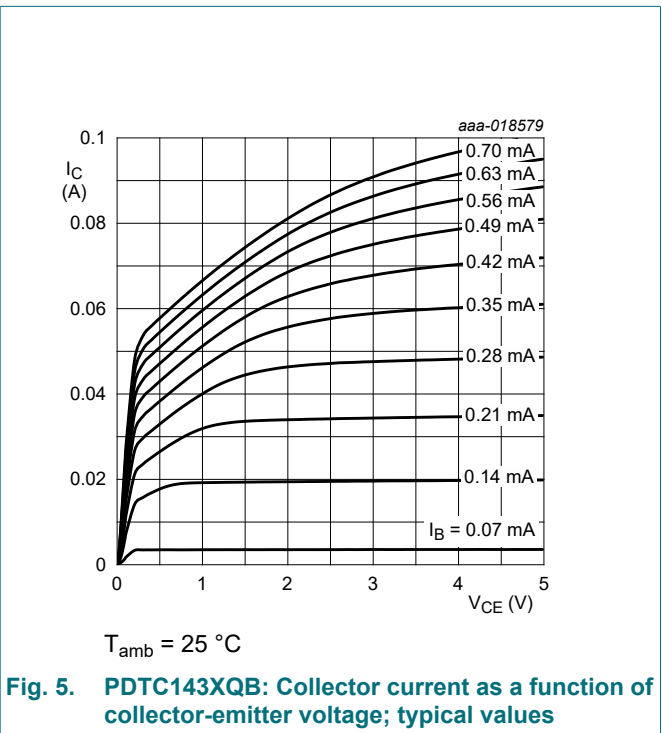
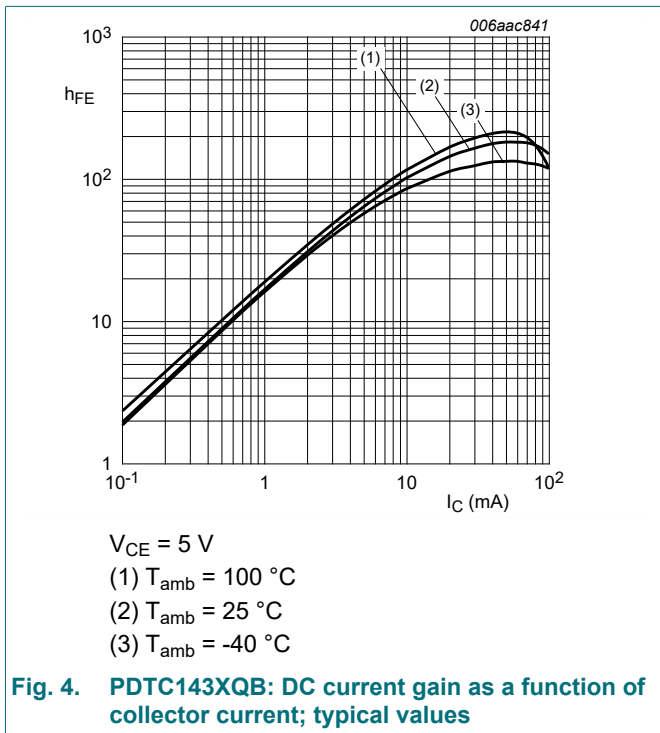
Table 8. Characteristics
 $T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = 100\ \mu\text{A}; I_E = 0\ \text{A}$	50	-	-	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = 2\ \text{mA}; I_B = 0\ \text{A}$	50	-	-	V
I_{CBO}	collector-base cut-off current	$V_{CB} = 50\ \text{V}; I_E = 0\ \text{A}$	-	-	100	nA
I_{CEO}	collector-emitter cut-off current	$V_{CE} = 30\ \text{V}; I_B = 0\ \text{A}$	-	-	100	nA
		$V_{CE} = 30\ \text{V}; I_B = 0\ \text{A}; T_j = 150\text{ °C}$	-	-	5	μA
I_{EBO}	emitter-base cut-off current					
	PDTC143XQB	$V_{EB} = 5\ \text{V}; I_C = 0\ \text{A}$	-	-	600	μA
	PDTC123JQB		-	-	180	μA
	PDTC143ZQB		-	-	170	μA
	PDTC114YQB		-	-	150	μA
	PDTC124XQB		-	-	120	μA
h_{FE}	DC current gain					
	PDTC143XQB	$V_{CE} = 5\ \text{V}; I_C = 10\ \text{mA}$	50	-	-	
	PDTC123JQB		100	-	-	
	PDTC143ZQB		100	-	-	
	PDTC114YQB	$V_{CE} = 5\ \text{V}; I_C = 5\ \text{mA}$	100	-	-	
	PDTC124XQB		80	-	-	
V_{CEsat}	collector-emitter saturation voltage					
	PDTC143XQB	$I_C = 10\ \text{mA}; I_B = 0.5\ \text{mA}$	-	-	100	mV
	PDTC123JQB		-	-	100	mV
	PDTC143ZQB	$I_C = 5\ \text{mA}; I_B = 0.25\ \text{mA}$	-	-	100	mV
	PDTC114YQB		-	-	100	mV
	PDTC124XQB		-	-	100	mV
$V_{I(off)}$	off-state input voltage					
	PDTC143XQB	$V_{CE} = 5\ \text{V}; I_C = 100\ \mu\text{A}$	-	0.8	0.3	V
	PDTC123JQB		-	0.6	0.5	V
	PDTC143ZQB		-	0.6	0.5	V
	PDTC114YQB		-	0.7	0.5	V
	PDTC124XQB		-	0.8	0.5	V
$V_{I(on)}$	on-state input voltage					
	PDTC143XQB	$V_{CE} = 0.3\ \text{V}; I_C = 20\ \text{mA}$	2.5	1.5	-	V
	PDTC123JQB	$V_{CE} = 0.3\ \text{V}; I_C = 5\ \text{mA}$	1.1	0.75	-	V
	PDTC143ZQB	$V_{CE} = 0.3\ \text{V}; I_C = 5\ \text{mA}$	1.3	0.9	-	V
	PDTC114YQB	$V_{CE} = 0.3\ \text{V}; I_C = 1\ \text{mA}$	1.4	0.8	-	V
	PDTC124XQB	$V_{CE} = 0.3\ \text{V}; I_C = 2\ \text{mA}$	2.0	1.1	-	V

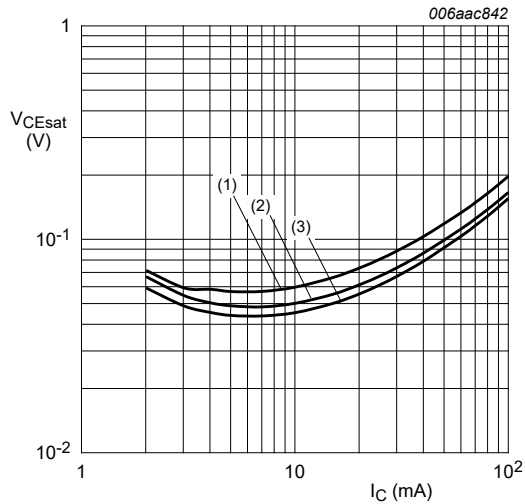
50 V, 100 mA NPN resistor-equipped transistors

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
R1	bias resistor 1 (input)					
	PDTC143XQB		[1] 3.3	4.7	6.1	kΩ
	PDTC123JQB		1.54	2.2	2.86	kΩ
	PDTC143ZQB		3.3	4.7	6.1	kΩ
	PDTC114YQB		7	10	13	kΩ
	PDTC124XQB		15.4	22	28.6	kΩ
R2/R1	bias resistor ratio					
	PDTC143XQB		[1] 1.7	2.13	2.6	
	PDTC123JQB		17	21	26	
	PDTC143ZQB		8	10	12	
	PDTC114YQB		3.7	4.7	5.7	
	PDTC124XQB		1.7	2.13	2.6	
f_T	transition frequency	$V_{CE} = 5\text{ V}; I_C = 10\text{ mA}; f = 100\text{ MHz}$	[2] -	230	-	MHz
C_c	collector capacitance	$V_{CB} = 10\text{ V}; I_E = I_e = 0\text{ A}; f = 1\text{ MHz}$	-	-	2.5	pF

- [1] See "Section 11: Test information" for resistor calculation and test conditions
- [2] Characteristics of built-in transistor



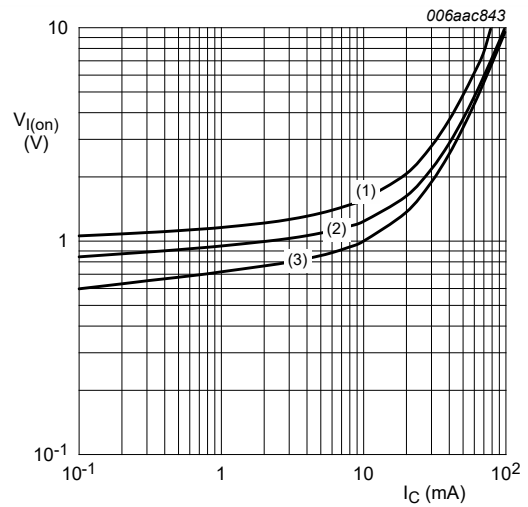
50 V, 100 mA NPN resistor-equipped transistors



$I_C/I_B = 20$

- (1) $T_{amb} = 100\text{ °C}$
- (2) $T_{amb} = 25\text{ °C}$
- (3) $T_{amb} = -40\text{ °C}$

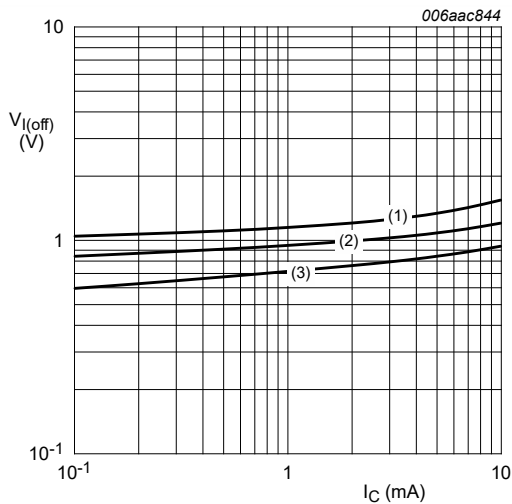
Fig. 6. PDTC143XQB: Collector-emitter saturation voltage as a function of collector current; typical values



$V_{CE} = 0.3\text{ V}$

- (1) $T_{amb} = -40\text{ °C}$
- (2) $T_{amb} = 25\text{ °C}$
- (3) $T_{amb} = 100\text{ °C}$

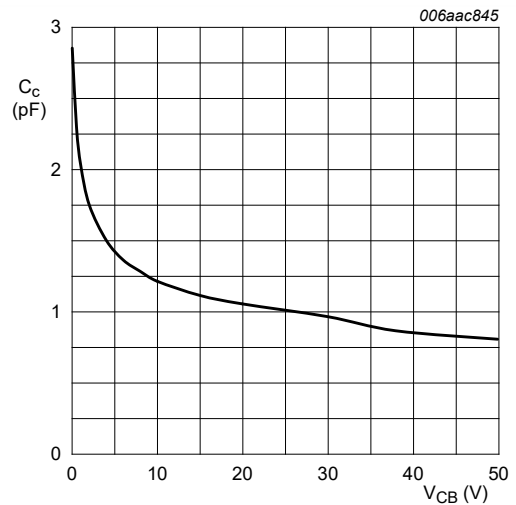
Fig. 7. PDTC143XQB: On-state input voltage as a function of collector current; typical values



$V_{CE} = 5\text{ V}$

- (1) $T_{amb} = -40\text{ °C}$
- (2) $T_{amb} = 25\text{ °C}$
- (3) $T_{amb} = 100\text{ °C}$

Fig. 8. PDTC143XQB: Off-state input voltage as a function of collector current; typical values



$f = 1\text{ MHz}$

$T_{amb} = 25\text{ °C}$

Fig. 9. PDTC143XQB: Collector capacitance as a function of collector-base voltage; typical values

50 V, 100 mA NPN resistor-equipped transistors

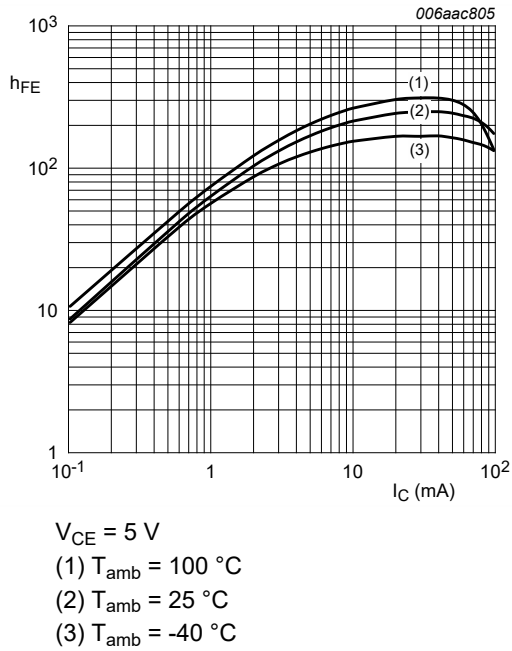


Fig. 10. PDTC123JQB: DC current gain as a function of collector current; typical values

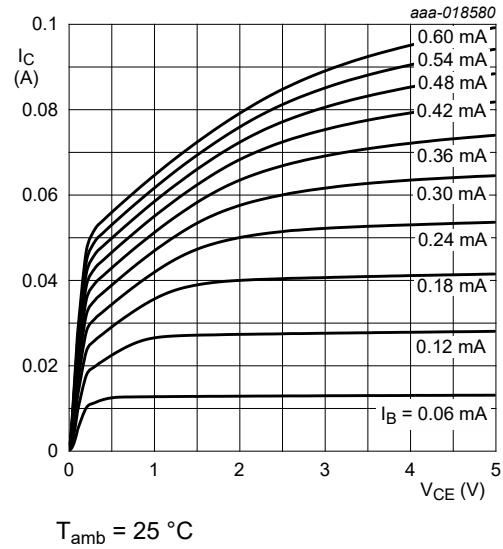


Fig. 11. PDTC123JQB: Collector current as a function of collector-emitter voltage; typical values

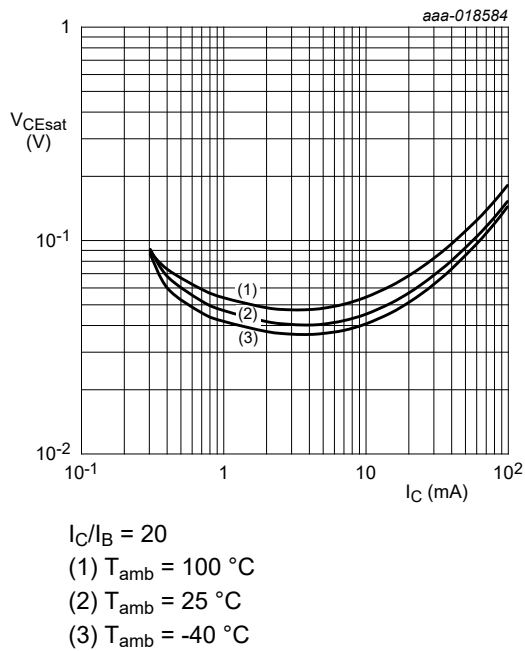


Fig. 12. PDTC123JQB: Collector-emitter saturation voltage as a function of collector current; typical values

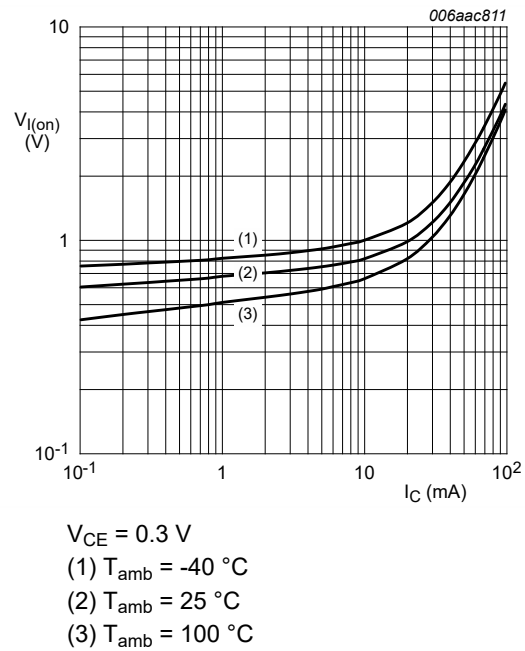


Fig. 13. PDTC123JQB: On-state input voltage as a function of collector current; typical values

50 V, 100 mA NPN resistor-equipped transistors

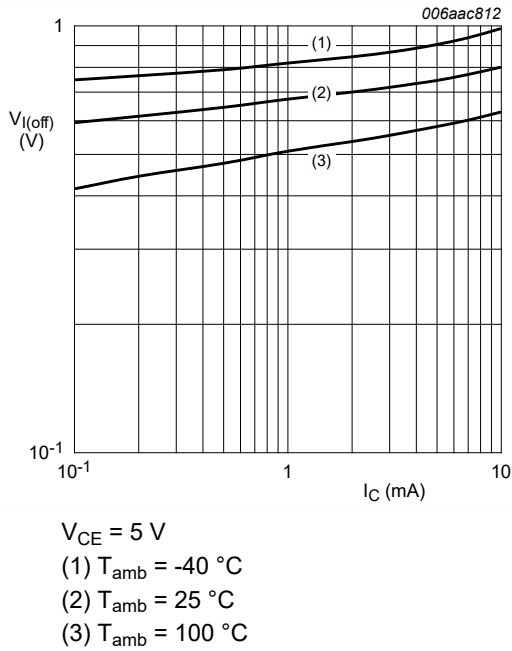


Fig. 14. PDTC123JQB: Off-state input voltage as a function of collector current; typical values

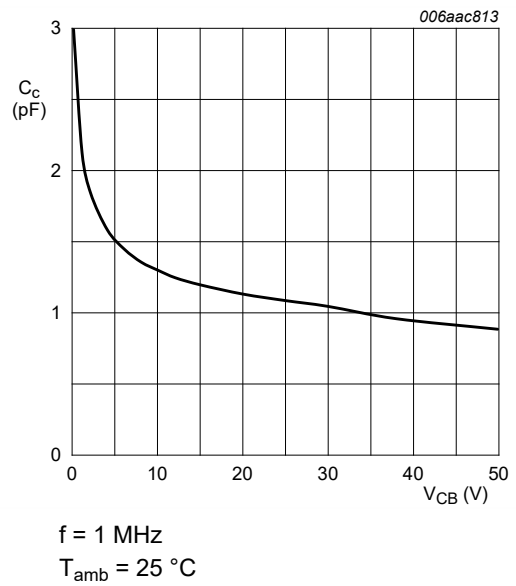


Fig. 15. PDTC123JQB: Collector capacitance as a function of collector-base voltage; typical values

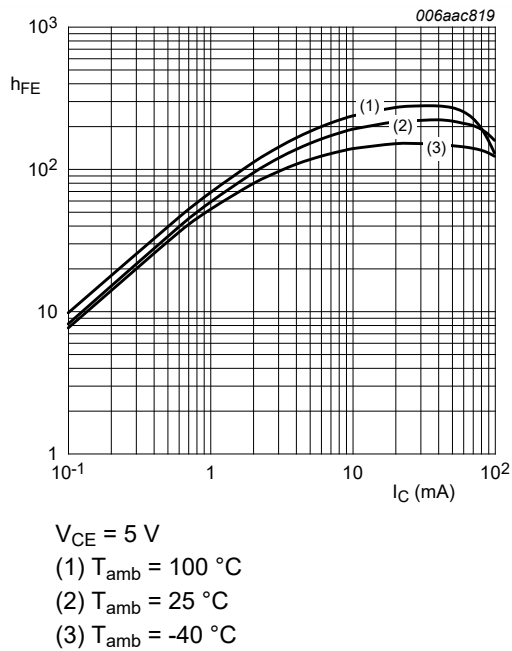


Fig. 16. PDTC143ZQB: DC current gain as a function of collector current; typical values

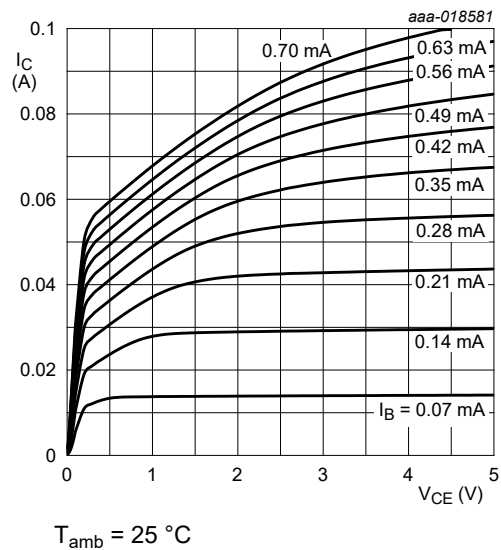
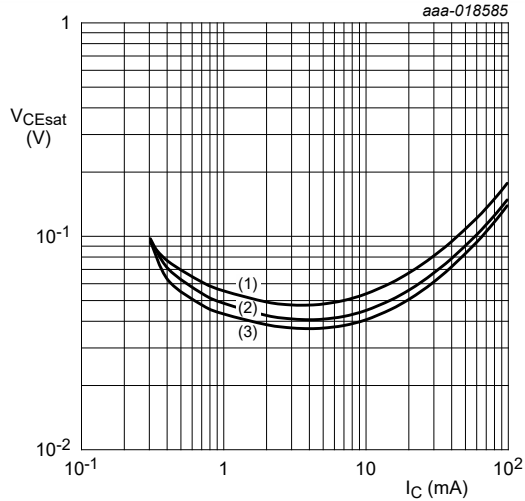


Fig. 17. PDTC143ZQB: Collector current as a function of collector-emitter voltage; typical values

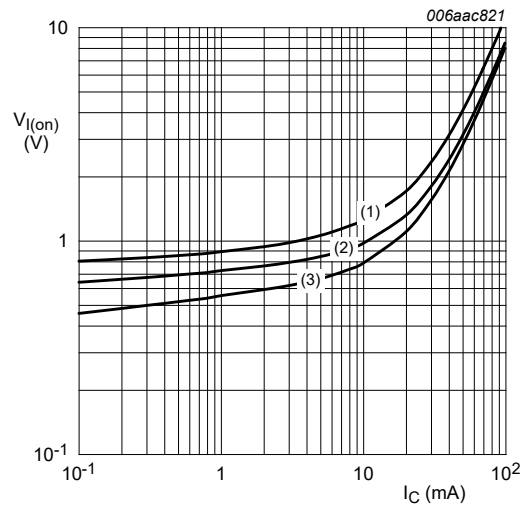
50 V, 100 mA NPN resistor-equipped transistors



$I_C/I_B = 20$

- (1) $T_{amb} = 100\text{ °C}$
- (2) $T_{amb} = 25\text{ °C}$
- (3) $T_{amb} = -40\text{ °C}$

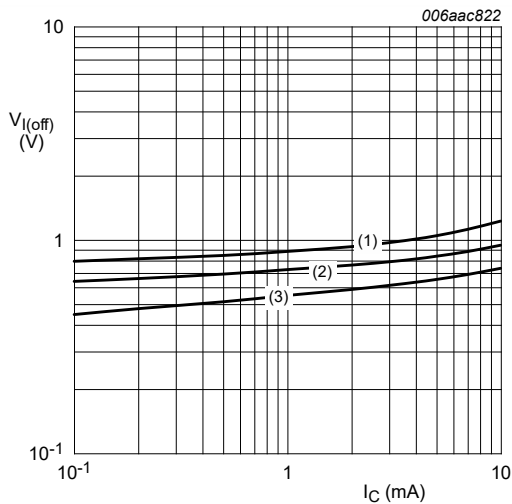
Fig. 18. PDTC143ZQB: Collector-emitter saturation voltage as a function of collector current; typical values



$V_{CE} = 0.3\text{ V}$

- (1) $T_{amb} = -40\text{ °C}$
- (2) $T_{amb} = 25\text{ °C}$
- (3) $T_{amb} = 100\text{ °C}$

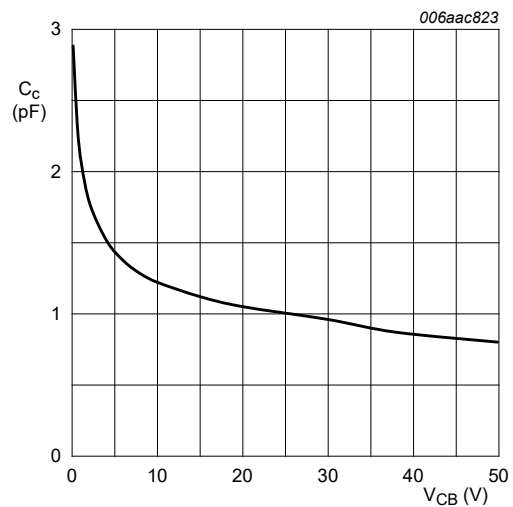
Fig. 19. PDTC143ZQB: On-state input voltage as a function of collector current; typical values



$V_{CE} = 5\text{ V}$

- (1) $T_{amb} = -40\text{ °C}$
- (2) $T_{amb} = 25\text{ °C}$
- (3) $T_{amb} = 100\text{ °C}$

Fig. 20. PDTC143ZQB: Off-state input voltage as a function of collector current; typical values



$f = 1\text{ MHz}$

$T_{amb} = 25\text{ °C}$

Fig. 21. PDTC143ZQB: Collector capacitance as a function of collector-base voltage; typical values

50 V, 100 mA NPN resistor-equipped transistors

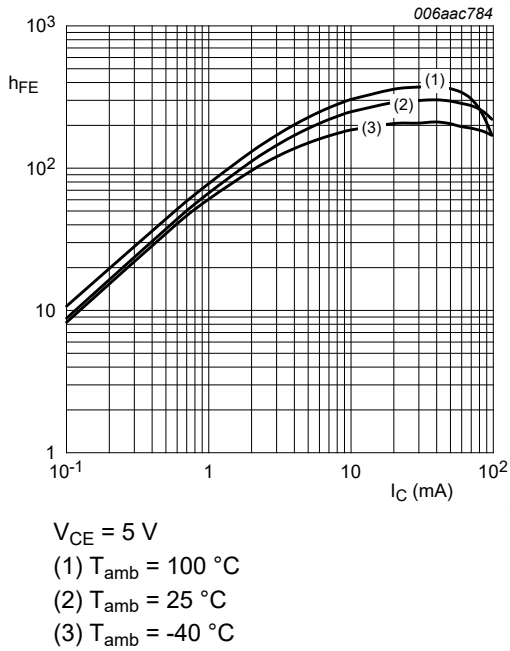


Fig. 22. PDTC114YQB: DC current gain as a function of collector current; typical values

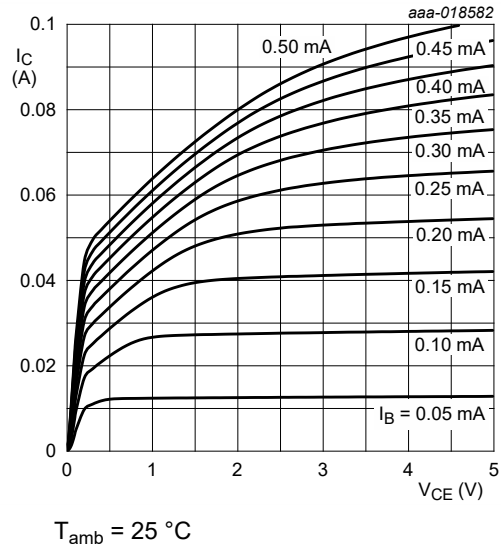


Fig. 23. PDTC114YQB: Collector current as a function of collector-emitter voltage; typical values

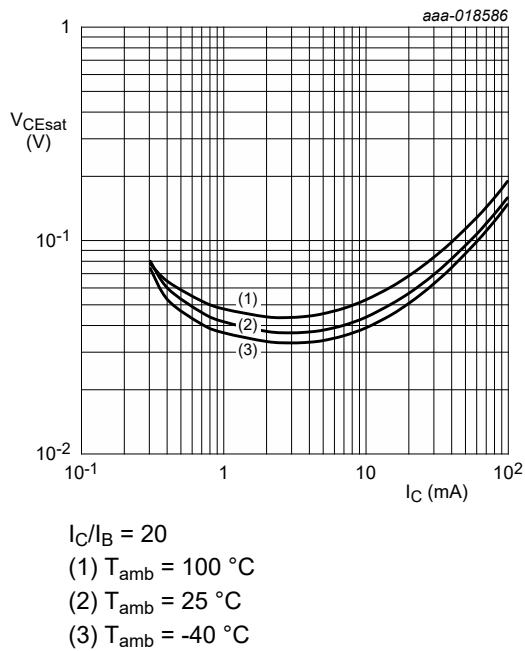


Fig. 24. PDTC114YQB: Collector-emitter saturation voltage as a function of collector current; typical values

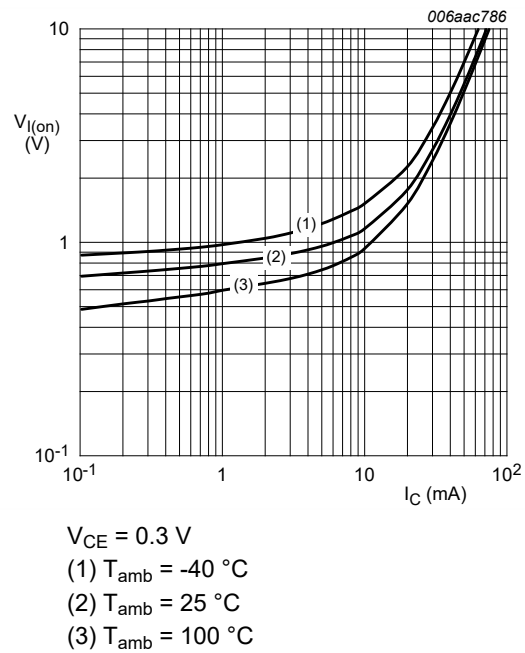


Fig. 25. PDTC114YQB: On-state input voltage as a function of collector current; typical values

50 V, 100 mA NPN resistor-equipped transistors

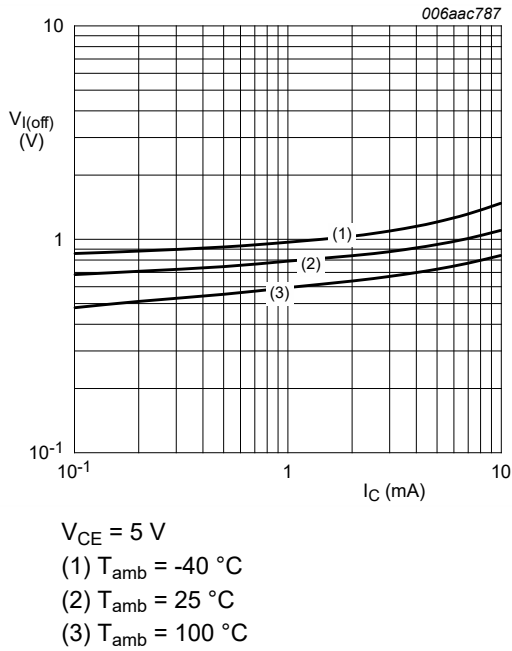


Fig. 26. PDTC114YQB: Off-state input voltage as a function of collector current; typical values

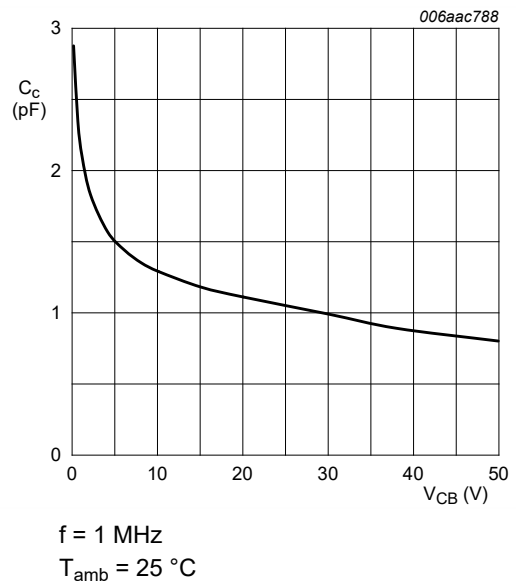


Fig. 27. PDTC114YQB: Collector capacitance as a function of collector-base voltage; typical values

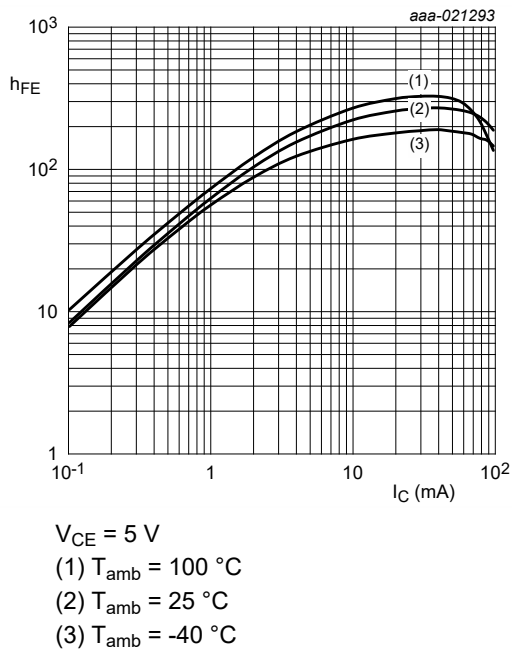


Fig. 28. PDTC124XQB: DC current gain as a function of collector current; typical values

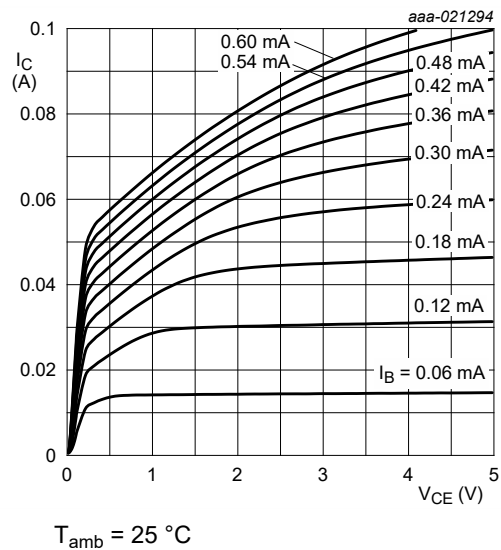
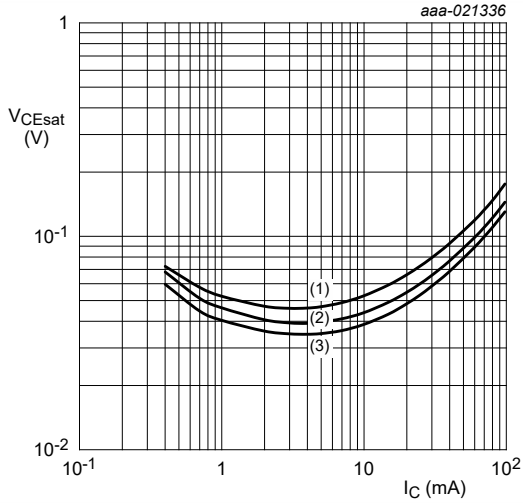


Fig. 29. PDTC124XQB: Collector current as a function of collector-emitter voltage; typical values

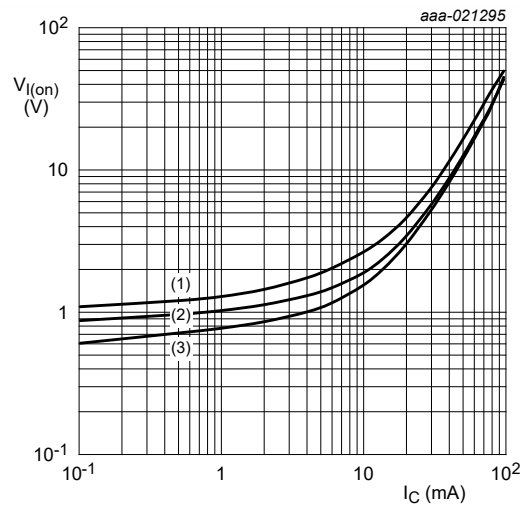
50 V, 100 mA NPN resistor-equipped transistors



$I_C/I_B = 20$

- (1) $T_{amb} = 100\text{ °C}$
- (2) $T_{amb} = 25\text{ °C}$
- (3) $T_{amb} = -40\text{ °C}$

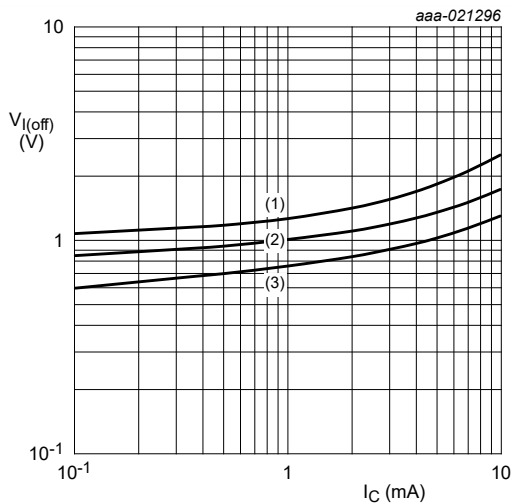
Fig. 30. PDTC124XQB: Collector-emitter saturation voltage as a function of collector current; typical values



$V_{CE} = 0.5\text{ V}$

- (1) $T_{amb} = -40\text{ °C}$
- (2) $T_{amb} = 25\text{ °C}$
- (3) $T_{amb} = 100\text{ °C}$

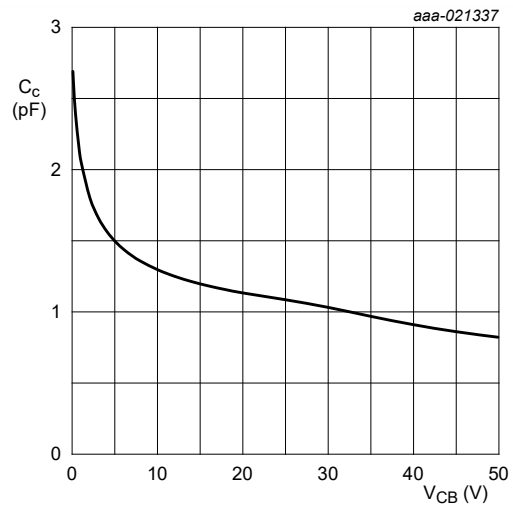
Fig. 31. PDTC124XQB: On-state input voltage as a function of collector current; typical values



$V_{CE} = 5\text{ V}$

- (1) $T_{amb} = -40\text{ °C}$
- (2) $T_{amb} = 25\text{ °C}$
- (3) $T_{amb} = 100\text{ °C}$

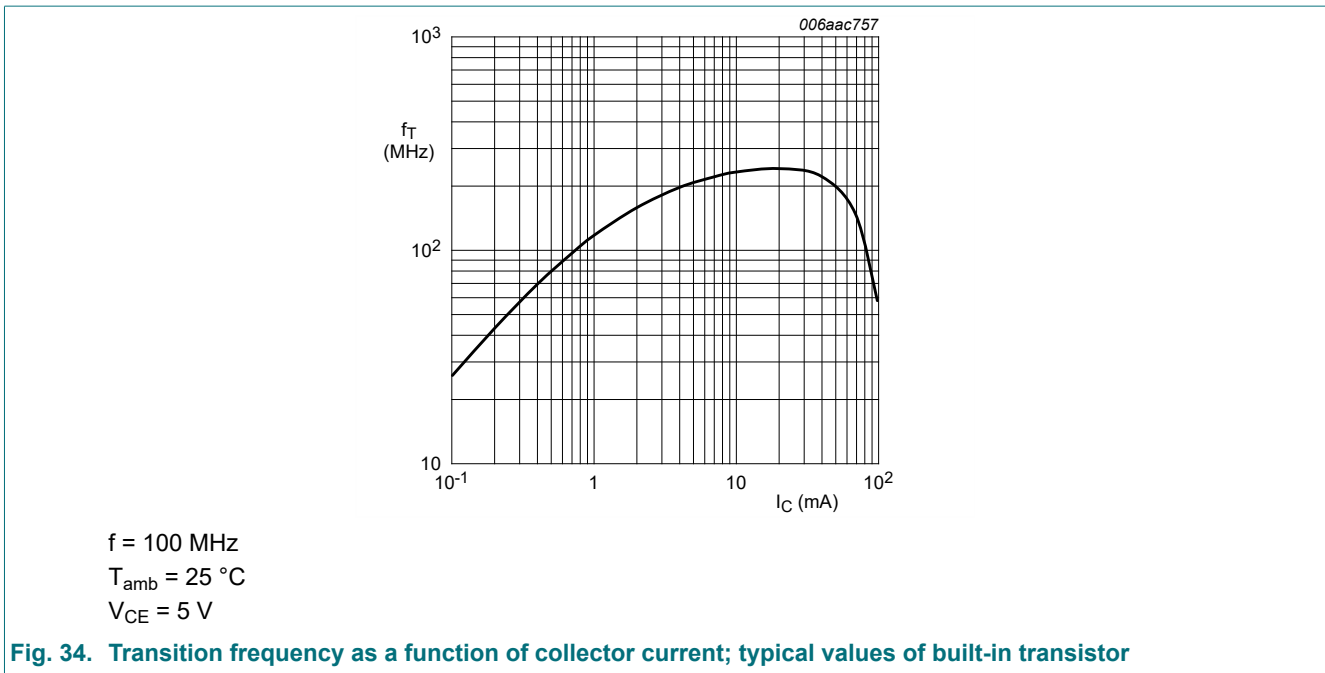
Fig. 32. PDTC124XQB: Off-state input voltage as a function of collector current; typical values



$f = 1\text{ MHz}$
 $T_{amb} = 25\text{ °C}$

Fig. 33. PDTC124XQB: Collector capacitance as a function of collector-base voltage; typical values

50 V, 100 mA NPN resistor-equipped transistors



11. Test information

Resistor calculation

- Calculation of bias resistor 1 (R1)

$$R1 = \frac{V(I12) - V(I11)}{I12 - I11}$$

- Calculation of bias resistor ratio (R2/R1)

$$\frac{R2}{R1} = \frac{V(I14) - V(I13)}{R1 \cdot (I14 - I13)} - 1$$

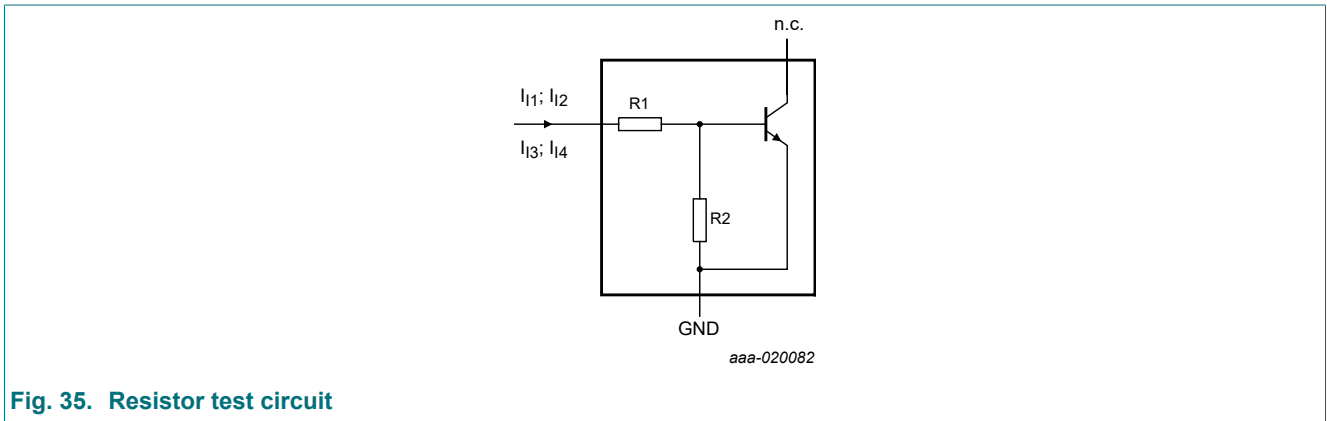


Fig. 35. Resistor test circuit

Resistor test conditions

Table 9. Resistor test conditions

Type number	R1 (kΩ)	R2 (kΩ)	Test conditions			
			I ₁₁	I ₁₂	I ₁₃	I ₁₄
PDTC143XQB	4.7	10	350 μA	450 μA	-350 μA	-450 μA
PDTC123JQB	2.2	47	90 μA	140 μA	-55 μA	-105 μA
PDTC143ZQB	4.7	47	90 μA	140 μA	-55 μA	-105 μA
PDTC114YQB	10	47	90 μA	140 μA	-55 μA	-105 μA
PDTC124XQB	22	47	55 μA	105 μA	-55 μA	-105 μA

12. Package outline

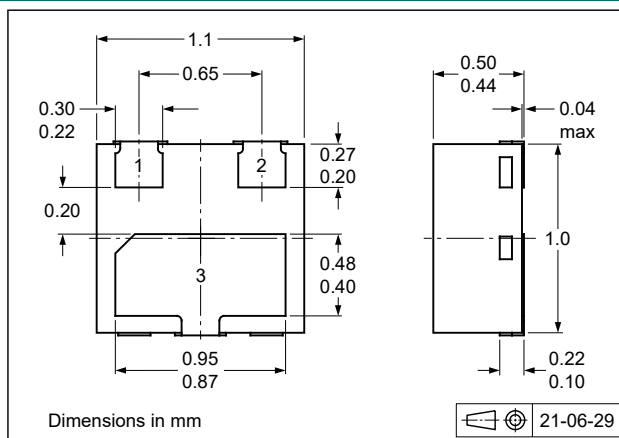


Fig. 36. Package outline DFN1110D-3 (SOT8015)

13. Soldering

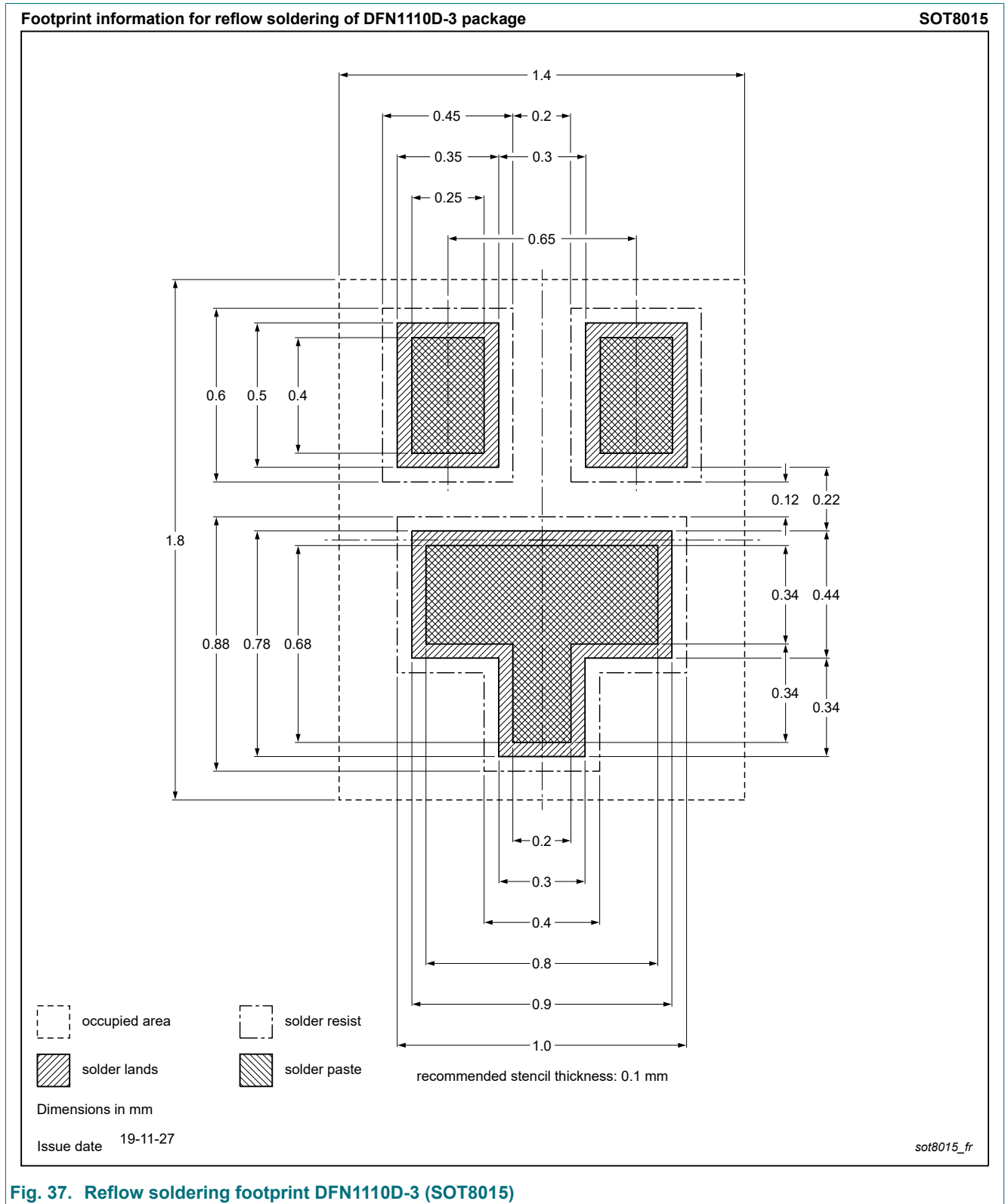


Fig. 37. Reflow soldering footprint DFN1110D-3 (SOT8015)

14. Revision history

Table 10. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PDTC143X_TO_124XQB_SER v.1	20211001	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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Date of release: 1 October 2021

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